EAST Search History

Ref#	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	17070	((light emitting diode) or "LED") chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:26
S2	1061480	((light emitting diode) or "LED")	US-PGPUB; USPAT; USCCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:26
S4	385	semiconductor light emitting chip	US-PGPUB; USPAT; USCCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:27
S5	22	(solid state) light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:28
S6	1061572	S1 or S2 or S4 or S5	US-PGPUB; USPAT; USCCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:28
\$7	595921	(circuit board) or ((printed circuit board) or "PCB")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:29

88	559851	circuit with S7	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:31
39	23162	S8 with S6	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:31
310	1449	\$9 with (capsulat\$4 or capsulant or encased or embed\$4 or laminat\$4 or layer\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:33
G11	137	(\$10 with (transparent or clear or (ligh transmit\$5) or refract\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:35
312	63	(\$11 and @ad < "20031223"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:36
313	5	(US-6893258-\$ or US-6743249-\$ or US-6595671-\$),did. or (JP-08202290-\$ or JP- (06095064-\$),did.	USPAT; JPO	NEAR	ON	2009/05/13 21:46
514	74	\$11 not \$12	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 21:46
S15	8	[US-20090099499-\$ or US-20090032825-\$ or US-20070030662-\$), did. or (US-20090032825-\$ or CN-200972986-\$ or KR-2007102320-\$ or CN-2934891-\$ or KR-2005100083-\$), did.	US-PGPUB; DERWENT	NEAR	ON	2009/05/13 21:57

S16	13	\$13 or \$15	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/13 21:57
317	317	S10 and "362"\$.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/13 21:59
518	243	S10 and "257"(\$.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/13 21:59
519	8	\$10 and "600"/\$.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/13 22:02
20	3	S10 and "604"/\$.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/13 22:02
21	8	S10 and "607"/\$.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/13 22:02
322	527	S17 or S18 or S19 or S20 or S21	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/13 22:03

S23	183	S22 and @ad < "20031223"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/13 22:03
S24	156	\$23 not \$11	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/13 22:03
325	6	(US-20020143373-\$), did. or (US-6874901-\$ or US-6059414-\$ or US-5771617-\$ or US-5475241-\$ or US-4865038-\$), did.	US-PGPUB; USPAT	NEAR	ON	2009/05/13 22:10
S26	19	S16 or S25	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/13 22:11
527	17104	((light emitting diode) or "LED") chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/14 09:41
S28	1062236	((light emitting diode) or "LED")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/14 09:41
629	385	semiconductor light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41

S30	22	(solid state) light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S31	1062328	S27 or S28 or S29 or S30	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
\$32	596344	(circuit board) or ((printed circuit board) or "PCB")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S33	560258	circuit with S32	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
\$34	23197	S33 with S31	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S35	1684	IS34 with (capsulat\$4 or capsulant or encased or embed\$4 or laminat\$4 or layer\$4 or encapsulat\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:41
S36	173	IS34 with (transparent or clear or (ligh transmit\$5) or refract\$4) with (capsulat\$4 or capsulant or encased or embed\$4 or laminat\$4 or layer\$4 or encapsulat\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:43

S37	79	\$36 and @ad < "20031223"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:44
538	7	(US-20050009242-\$),did. or (US-6893258-\$ or US-6743249-\$ or US-6595671-\$), did. or (JP-08202290-\$ or JP-06095064-\$),did. or (WO-9724770-\$),did.	US-PGPUB; USPAT; JPO; DERWENT	NEAR	ON	2009/05/14 09:54
S39	5	(US-6893258-\$ or US-6743249-\$ or US-6595671-\$),did. or (JP-08202290-\$ or JP-06095064-\$),did.	USPAT; JPO	NEAR	ON	2009/05/14 09:55
340	8	[(US-20090099499-\$ or US-20090032825-\$ or US-20070030662-\$).did. or (US- 20090032825-\$ or CN-200972986-\$ or KR-2007102320-\$ or CN-2934891-\$ or KR- 2005100083-\$).did.	US-PGPUB; DERWENT	NEAR	ON	2009/05/14 09:55
S41	13	S39 or S40	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:55
342	6	(US-20020143373-\$),did. or (US-6874901-\$ or US-6059414-\$ or US-5771617-\$ or US-5475241-\$ or US-4865038-\$),did.	US-PGPUB; USPAT	NEAR	ON	2009/05/14 09:55
643	19	S41 or S42	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:55
S44	21	S38 or S43	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/14 09:55
645	17185	((light emitting dicde) or "LED") chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30

S46	1063520	((light emitting diode) or "LED")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S47	386	semiconductor light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S48	22	(solid state) light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S49	1063613	S45 or S46 or S47 or S48	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S50	597412	(circuit board) or ((printed circuit board) or "PCB")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S51	26058	S50 with S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:30
S52	1712	IS50 and (S49 with (laminat\$4 or embed\$3))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:32

S53	1083	S50 and (S49 with (laminat\$4 or embed\$3)) and (transparent or clear or (ligh transmit\$5) or refract\$4)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:34
S54	178	S50 and ((S49 with (laminat\$4 or embed\$3)) with (transparent or clear or (ligh transmit\$5) or refract\$4))	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:35
S55	83	S54 and @ad < "20031223"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 09:42
S56	9709	362/153,320,330,471,479,488,490,492,1606,607,608,611- 613,617,619,619,621,630,631,632,543-546,800,806.ccls.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 12:15
S57	5207	S56 and S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 12:16
S58	78	S56 and S53	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 12:17
S59	38	S58 and @ad < "20031223"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 12:18

360	88	362/490,479.ccls. and S49	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 12:26
361	5	(US-20020167820-\$),did. or (US-6666571-\$ or US-6464381-\$ or US-6402354-\$ or US-6203180-\$),did.	US-PGPUB; USPAT	NEAR	ON	2009/05/18 12:52
662	6	["5079675" "5520434" "6019411" "6331065").PN. OR ("6666571").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 12:54
63	1	(US-7284886-\$).did.	USPAT	NEAR	ON	2009/05/18 12:57
664	79	[(3545110" "4104555" "4109235" "4138620" "4181925" "4297681" "4328532" "4365232" "4499451" "4561042" "4578617" "4580196" "4581683" "4647337" "4667273" "4754372" "4864473" "4951177" "4959759" "5013967" "5124845" "5142274" "5267167" "5272603" "5329429" "5339550" "5347434" "514598" "5434013" "5444757" "5441339" "5479275" "5499170" "5504661" "5516143" "5549323" "5558364" "5564813" "5565733" "5566384" "5671996" "5803579" "5811930" "5917666" "5938321" "6008732" "6042634" "6082667" "6086131" "6087953" "6101032" "611622" "6110551" "6124647" "6132072" "6139172" "6140934" "6144424" "6160475").PN. OR ("6464381"). URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 12:57
65	10	(5938321").PN. OR ("6402354").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:12
666	29	["4158223" "4794373" "5661374" "5803579").PN. OR ("6203180").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:13
67	29	["4158223" "4794373" "5661374" "5803579").PN. OR ("6203180").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:21
668	29	("4158223" "4794373" "5661374" "5803579").PN. OR ("6203180").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:22
69	1	(US-7163305-§).did.	USPAT	NEAR	ON	2009/05/18 13:22
570	29	["4158223" "4794373" "5661374" "5803579").PN. OR ("6203180").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:23
71	25	("3755663" "4104555" "4143297" "4159559" "4608308" "4631650" "4654765" "4661373" "4719405" "4994944" "5051654" "5144117").PN. OR ("5661374").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:24
372	2	(US-7163305-\$ or US-5661374-\$).did.	USPAT	NEAR	ON	2009/05/18 13:26

S73	7)(US-PGPUB; USPAT; JPO; DERWENT	NEAR	ON	2009/05/18 13:27
 374	5	(US-6893258-\$ or US-6743249-\$ or US-6595671-\$).did. or (JP-08202290-\$ or JP- 06095064-\$).did.	USPAT; JPO	NEAR	ON	2009/05/18 13:27
S75	8	(US-20090099499-\$ or US-20090032825-\$ or US-20070030662-\$),did. or (US-20090032825-\$ or CN-200972986-\$ or KR-2007102320-\$ or CN-2934891-\$ or KR-2005100083-\$),did.	US-PGPUB; DERWENT	NEAR	ON	2009/05/18 13:27
S76	13		US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 13:27
 377	6		US-PGPUB; USPAT	NEAR	ON	2009/05/18 13:27
S78	19	S76 or S77	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 13:27
S79	21	S73 or S78	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 13:27
S80	16	S69 or S72 or S63 or S79	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 13:27
381	3	(US-7284886-\$ or US-7163305-\$ or US-5661374-\$).did.	USPAT	NEAR	ON	2009/05/18 13:33
 382	2	("6890089").PN.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	OR	OFF	2009/05/18 13:33
S83	1	(US-6890089-\$).did.	USPAT	NEAR	ON	2009/05/18 13:34

S84	5	S81 or S82	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/18 13:35
85	4	(US-7284886-\$ or US-7163305-\$ or US-5661374-\$ or US-6890089-\$),did.	USPAT	NEAR	ON	2009/05/18 13:35
395	17185	((light emitting diode) or "LED") chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/18 19:34
96	1063520	((light emitting diode) or "LED")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34
97	386	semiconductor light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34
98	22	(solid state) light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/18 19:34
99	1063613	S95 or S96 or S97 or S98	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34

S100	597412	(circuit board) or ((printed circuit board) or "PCB")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34
\$101	145	[\$100 and ((\$99 with (laminat)\$4 or embed\$3)) with (transparent or clear or (ligh transmit\$5) or refract\$4)) and (housing or case or casing)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:34
3102	65	S101 and @ad < "20031223"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/18 19:35
S103	12	("20020167820" "20020172039" "20050073851" "20050128760" "5101325" 6152569" "6240664" "6331065" "6666571" "6742907" "6890089" 77118239"),PN. OR ("7284886"),URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 19:40
S104	29	("4158223" "4794373" "5661374" "5803579").PN. OR ("6203180").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 19:58
3105	3	"6890089"	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/18 20:00
S106	2	"20080259623"	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 09:40
S107	1	(S106 and integral\$3 and laminal\$4	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 09:40
S108	1	S106 and integral\$3 and laminal\$4 and (output element)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:11

S109	1	S106 and (output element)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/19 10:11
S111	17195	((light emitting diode) or "LED") chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/19 10:50
S112	1063914	((light emitting diode) or "LED")	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/19 10:50
S113	386	semiconductor light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/19 10:50
S114	22	(solid state) light emitting chip	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/19 10:50
S115	1064007	S111 or S112 or S113 or S114	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/19 10:50
S116	77656	(laminat\$4 glass) or (layer\$4 glass)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/19 10:51

3117	689	(laminat\$4 glass panel) or (layer\$4 glass panel)	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:52
118	77656	\$116 or \$117	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:52
119	6066	S115 and S118	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:52
120	24	S115 with "in" with S118	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:53
121	7	S115 with "within" with S118	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:53
122	31	S120 or S121	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 10:54
123	9	("20020024981" "20030025572" "20030087463" "4643532" "5376580" "6287882" "6292243" "6417478" "6861281").PN. OR ("7119375").URPN.	US-PGPUB; USPAT; USOCR	NEAR	ON	2009/05/19 11:28
124	6	("2552955").URPN.	USPAT	NEAR	ON	2009/05/19 11:30

S125	0	day-stephen-\$.in	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 12:58
S126	37	day-stephen-\$.in.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 12:59
S127	0	"gb-0216787.2-"\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 13:03
S128	0	*GB-0216787*\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 13:04
6129	0	GB-0216787-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 13:04
6130	0	GB-02167872-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 13:04
S131	0	"02167872"	FPRS; EPO	NEAR	ON	2009/05/19 13:05
132	27	DAY-STEPHEN.IN.	FPRS; EPO	NEAR	ON	2009/05/19 13:06
3133	12	{"20010055458" "3317906" "4636696" "4761720" "4968895" "5193895" \$"5650208" "5890794" "6208031" "6270236" "6281525" "6361867").PN.	US-PGPUB; USPAT	NEAR	ON	2009/05/19

S134	32	("3317906").URPN.	USPAT	NEAR	ON	2009/05/19 13:30
S135	2	(("3317906") or ("6361867")).PN.	USPAT	OR	OFF	2009/05/19 14:27
S136	1	(US-6361867-\$).did.	USPAT	NEAR	ON	2009/05/19 14:29
S137	1	DE-4431890-\$.DID.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/19 14:30
S138	1	(GB-2281683-\$).did.	DERWENT	NEAR	ON	2009/05/19 14:31
S139	0	JP-2084684-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 14:33
S140	1	JP-02084684-\$.did.	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; BM_TDB	NEAR	ON	2009/05/19 14:33
S141	2	S137 or S138 or S140	US-PGPUB; USPAT; USOCR; FPRS; EPO; JPO; DERWENT; IBM_TDB	NEAR	ON	2009/05/19 14:37

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